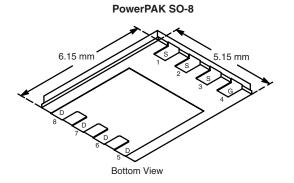
**New Product** 



Si7137DP **Vishay Siliconix** 

# P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A)	Q <sub>g</sub> (Тур.)			
	0.00195 at V <sub>GS</sub> = - 10 V	- 60 <sup>d</sup>				
- 20	0.0025 at V <sub>GS</sub> = - 4.5 V	- 60 <sup>d</sup>	183 nC			
	0.0039 at $V_{GS}$ = - 2.5 V	- 60 <sup>d</sup>				

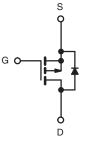


**FEATURES** 

- Halogen-free According to IEC 61249-2-21 • Definition
- TrenchFET<sup>®</sup> Gen III P-Channel Power MOSFET
- 100 % R<sub>a</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### APPLICATIONS

- Adaptor Switch
- **Battery Switch**
- Load Switch



<b>Ordering Information</b>	Si7137DP-T1-GE3 (Lead (Pb)-free and Halogen-free)
-----------------------------	---------------------------------------------------

P-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	- 20	v	
Gate-Source Voltage		V <sub>GS</sub>	± 12	v	
	T <sub>C</sub> = 25 °C		- 60 <sup>d</sup>		
Continuous Drain Current ( $T_{I}$ = 150 °C)	T <sub>C</sub> = 70 °C		- 60 <sup>d</sup>		
Continuous Drain Current $(T_j = 150^{\circ} C)$	T <sub>A</sub> = 25 °C		- 42 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		- 33.7 <sup>a, b</sup>		
Pulsed Drain Current		I <sub>DM</sub>	- 100	— A	
Continuous Source Droin Diada Current	T <sub>C</sub> = 25 °C	1-	- 60 <sup>d</sup>		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 5.6 <sup>a, b</sup>		
Avalanche Current L = 0.1 mH		I <sub>AS</sub>	- 50		
Single-Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	125	mJ	
	T <sub>C</sub> = 25 °C		104		
Marian Brance Bianteria	T <sub>C</sub> = 70 °C		66.6		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	6.25 <sup>a, b</sup>	W	
	T <sub>A</sub> = 70 °C		4.0 <sup>a, b</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		
Soldering Recommendations (Peak Temperature) <sup>e, f</sup>		, , , , , , , , , , , , , , , , , , ,	260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	15	20	°C/W
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	0.9	1.2	C/W

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 54 °C/W.

d. Package limited.

f. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.



COMPLIANT

HALOGEN FREE

e. See Solder Profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

# Si7137DP

# Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	- 20			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 14.5		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_{\rm D} = -250 \mu{\rm A}$		4.1		mv/-
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.5		- 1.4	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 1 - 5	μA
On Chata Duain Coursent?	I= ( )	$V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 40		- 5	А
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{\rm DS} \ge -10$ V, $V_{\rm GS} = -10$ V V <sub>GS</sub> = -10 V, I <sub>D</sub> = -25 A	- 40	0.0016	0.00105	A
	P	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -20 \text{ A}$		0.0016	0.00195	_
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>			0.002	0.0025	Ω
	~	$V_{GS} = -2.5 V, I_D = -15 A$		0.0031	0.0039	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 25 A		95		S
Dynamic <sup>b</sup>						1
Input Capacitance	C <sub>iss</sub>			20 000		_
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -10 V$ , $V_{GS} = 0 V$ , f = 1 MHz		2150		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			2650		
Total Gate Charge	Q <sub>q</sub>	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -20 \text{ A}$	$0 \text{ V}, \text{ V}_{\text{GS}} = -10 \text{ V}, \text{ I}_{\text{D}} = -20 \text{ A}$ 390		585	
Total Gate Charge	Чg			188	282	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -20 \text{ A}$		33.6		110
Gate-Drain Charge	Q <sub>gd</sub>			46		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.9	1.8	3.6	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			20	40	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 1 $\Omega$		14	28	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 10 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		230	400	
Fall Time	t <sub>f</sub>			72	125	
Turn-On Delay Time	t <sub>d(on)</sub>			100	170	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 1 $\Omega$		150	255	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 10 A, $V_{GEN}$ = - 4.5 V, $R_q$ = 1 $\Omega$		230	390	
Fall Time	t <sub>f</sub>			110	190	
Drain-Source Body Diode Characterist						
Continous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 60	
Pulse Diode Forward Current	I <sub>SM</sub>	Ĭ			- 100	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 5 A, V <sub>GS</sub> = 0 V		- 0.64	- 1.1	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			88	140	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			105	160	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_{F} = -10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_{J} = 25 ^{\circ}\text{C}$		25		
Reverse Recovery Rise Time	t <sub>a</sub>	4		63		ns

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

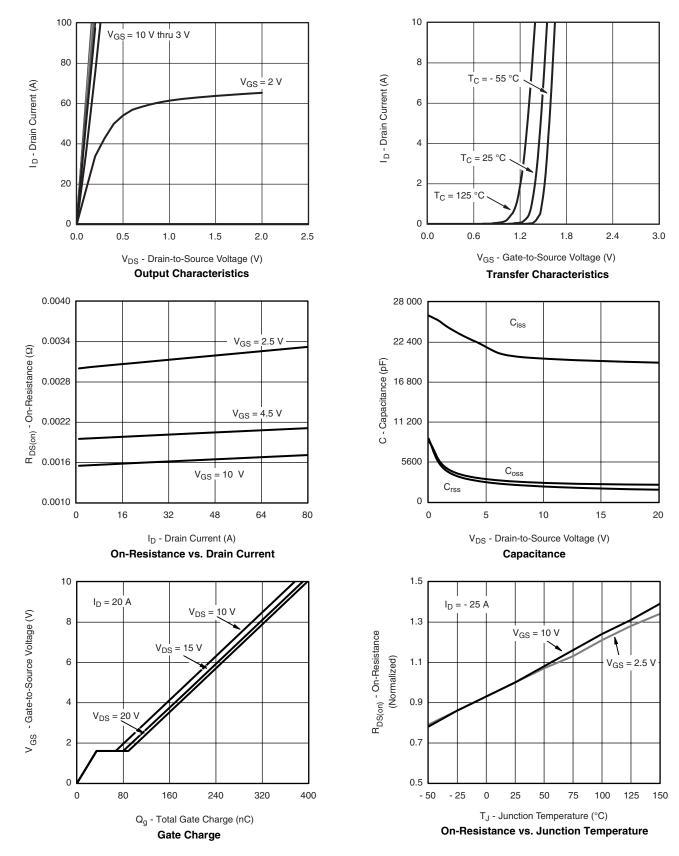
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



## Si7137DP Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Document Number: 69063 S09-0865-Rev. D, 18-May-09

# Si7137DP

## Vishay Siliconix



 $I_{D} = -25 \text{ A}$ 

T<sub>J</sub> = 125 °C

 $T_J = 25 \ ^\circ C$ 

10

1

6

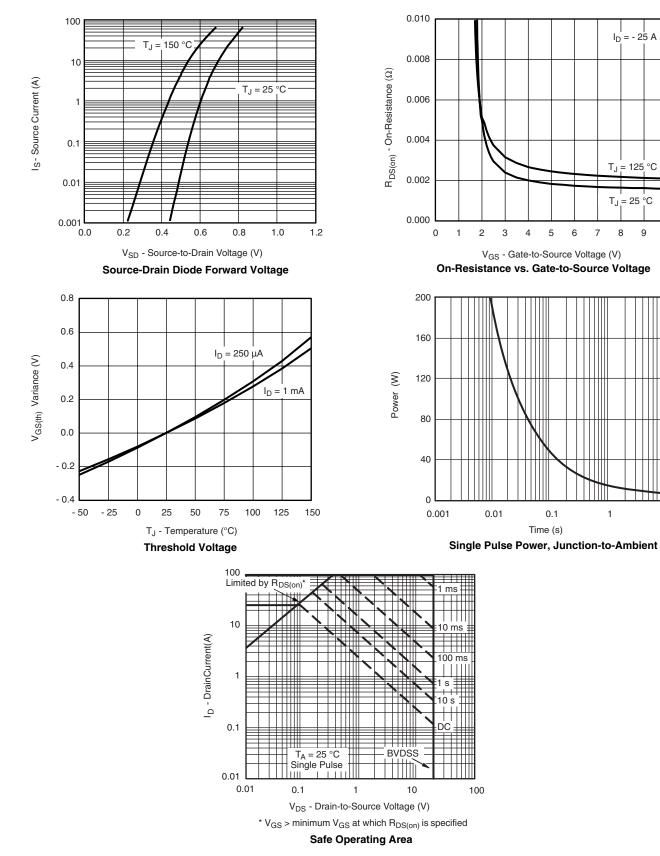
0.1

Time (s)

7 8 9 10

4 5

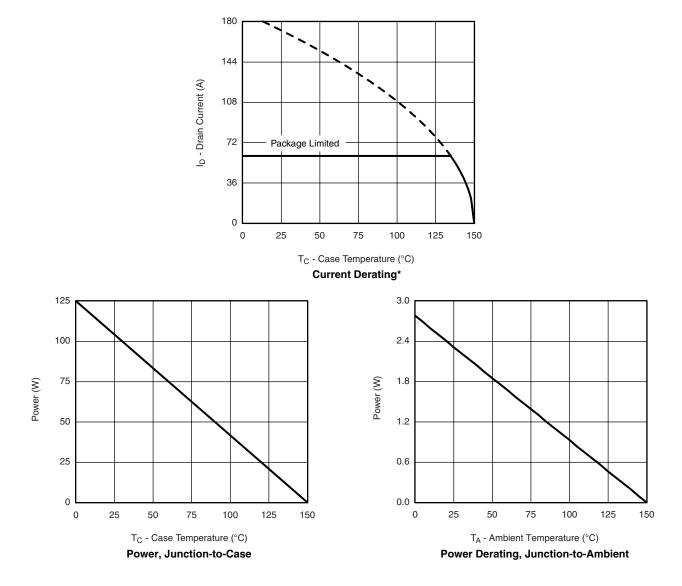
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





## Si7137DP Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



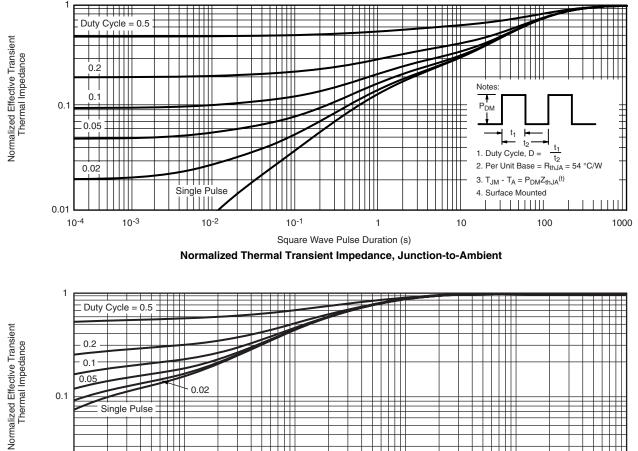
\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

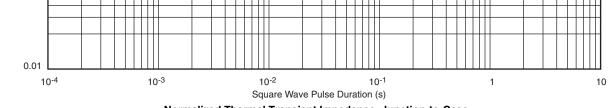
# Si7137DP

### **Vishay Siliconix**



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





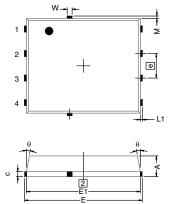
Normalized Thermal Transient Impedance, Junction-to-Case

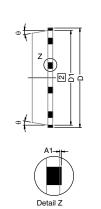
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?69063">www.vishay.com/ppg?69063</a>.

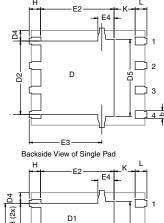


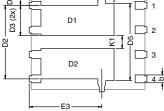
**Vishay Siliconix** 

# PowerPAK<sup>®</sup> SO-8, (Single/Dual)









Backside View of Dual Pad

Notes

1. Inch will govern.

2 Dimensions exclusive of mold gate burrs.

3. Dimensions exclusive of mold flash and cutting burrs.

		MILLIMETERS			INCHES		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
A	0.97	1.04	1.12	0.038	0.041	0.044	
A1		-	0.05	0	-	0.002	
b	0.33	0.41	0.51	0.013	0.016	0.020	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	5.05	5.15	5.26	0.199	0.203	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.56	3.76	3.91	0.140	0.148	0.154	
D3	1.32	1.50	1.68	0.052	0.059	0.066	
D4		0.57 typ.			0.0225 typ.		
D5		3.98 typ.			0.157 typ.		
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	5.79	5.89	5.99	0.228	0.232	0.236	
E2 (for AL product)	3.30	3.48	3.66	0.130	0.137	0.144	
E2 (for other product)	3.48	3.66	3.84	0.137	0.144	0.151	
E3	3.68	3.78	3.91	0.145	0.149	0.154	
E4 (for AL product)		0.58 typ.		0.023 typ.			
E4 (for other product)		0.75 typ.			0.030 typ.		
е		1.27 BSC		0.050 BSC			
K (for AL product)		1.45 typ.		0.057 typ.			
K (for other product)		1.27 typ.		0.050 typ.			
K1	0.56	-	-	0.022	-	-	
Н	0.51	0.61	0.71	0.020	0.024	0.028	
L	0.51	0.61	0.71	0.020	0.024	0.028	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М	0.125 typ.			0.005 typ.			

Revison: 20-May-13

Document Number: 71655



# Application Note 826

Vishay Siliconix

#### RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Vishay

# Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

# **Material Category Policy**

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.